

Stacked Metamaterial Patch Antenna Made of Low Permittivity Dielectrics

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Abstract – A new concept of “*meta-lo*” architecture is contributed to build compact and broadband stacked metamaterial patch antennas (SMPAs). The new antennas are featured with planar mushroom metamaterials that are all made of low permittivity dielectrics. These metamaterials work as good alternatives to conventional high permittivity dielectrics, enabling the new antenna to resonate at a much lower frequency. To examine the antenna performances, one SMPA is experimentally demonstrated. The new antenna is observed to have a broad bandwidth of 27% in a volume of $0.26\lambda \times 0.26\lambda \times 0.107\lambda$. The average antenna gain is 7.1 dBi in the operating bandwidth. The compact and broadband SMPA inspired by the *meta-lo* architecture is promising to be used in the high-speed mobile communications.

Index Terms – Broadband, compact, metamaterials, stacked patch antenna.

I. INTRODUCTION

For a long time (over 10 years), it has been deemed necessary to use material combinations of *high* and *low* (*hi-lo*) index dielectrics [1–3] to design a high-performance compact stacked patch antenna, which can be used in the handset high-speed communications. These stacked antennas based on the *hi-lo* architecture [1–3] were demonstrated with smaller parasitic and driven patches than the original stacked antennas made of a low index dielectric and air/foam [4–8]. A main limitation for these *hi-lo* stacked antennas is that high permittivity dielectrics are indispensable [1].

In this effort, a new “*meta-lo*” architecture is contributed to address the problem without utilization of any high permittivity dielectrics. In the *meta-lo* architecture, the lower substrate is now filled with metamaterials [9–12] as good alternatives to the high permittivity dielectrics, while the upper substrate is still a low index dielectric. It is hence named “*meta-lo*” after such ma-

terial combinations of *metamaterials* and *low* index dielectrics. Metamaterials are composed of subwavelength functional structures that are designed included in a host natural material [9–12]. This host natural material itself might be with a low permittivity. However due to the functional inclusions, the metamaterials may exhibit an increasingly higher effective permittivity and/or permeability than the host. This idea provides a new method to make patch antennas smaller [13–20], in which only low permittivity dielectrics are utilized. Inspired by the metamaterial technology, mushroom metamaterials [20] are chosen in this contribution as the lower substrate. A particular advantage for these mushroom metamaterial structures is their planar prototype that can be well integrated into a low profile patch antenna and easily manufactured with the current printed circuit board (PCB) process.

The stacked metamaterial patch antennas (SMPAs) based on the *meta-lo* architecture are numerically studied in the Ansys HFSS solver. One particular SMPA is further experimentally demonstrated. It is observed to have a broad impedance bandwidth (BW) from 3.371 to 4.427 GHz (27.1%). The SMPA occupies a much smaller size than its counterpart built from a low index dielectric and air [4–8]. If we use the free space wavelength λ at the center frequency f_c (3.899 GHz) in the broad BW to measure the SMPA, we have $\lambda = 76.9$ mm. The parasitic patch size is 20 mm \times 20 mm ($0.26\lambda \times 0.26\lambda$). The driven square patch is even smaller with side length of 0.21λ . The total thickness for the SMPA is 8.2 mm (0.107λ) in low profile. It is a particularly amazing result that such a compact SMPA is made of dielectrics all with low dielectric constant of 3. In addition, the *meta-lo* architecture does not sacrifice the antenna gain. The measured average antenna gain of the SMPA is 7.1 dBi in the entire BW. The radiation patterns are all observed with suppressed back lobes and cross polarizations, which benefits the directive radiation to the upper half space. We remark that a preliminarily numerical design for the SMPA

was shortly reported in a conference [21]. However, new great advances are made in this work, including the introduction and discussion of new *meta-lo* architecture, numerical optimizations, and particularly, experimental demonstration.

II. CONCEPT OF THE META-LO ARCHITECTURE

To design a compact stacked patch antenna, the traditional method is to use a *hi-lo* architecture [1–3], which is shown in Fig. 1 (a). It includes a parasitic patch mounted on an upper low index dielectric with dielectric constant ϵ_{ru} , and a driven patch on a lower high index dielectric with ϵ_{rl} . These two patches are loosely coupled to form an equivalent multi-resonant circuit and make a broad BW. Note that in the *hi-lo* architecture, a high permittivity dielectric is indispensable. To address the problem, an alternative *meta-lo* architecture is proposed in Fig. 1 (b), in which a metamaterial substrate is used to replace the high index substrate in the previous *hi-lo* architecture. The metamaterial substrate is made of low permittivity dielectrics, but exhibit an increased effective permittivity ϵ_{reff} .

Following the *meta-lo* architecture, a practical SMPA is designed with planar mushroom metamaterials [20] as the *effective* lower substrate, while the upper substrate is still made of a natural dielectric. The metamaterial substrate is physically built from two PCB layers. As a multilayered antenna, the conceptual SMPA now includes three (top, middle, and bottom) laminate layers shown in Fig. 2 (a). The top layer works as the upper layer in the conventional *hi-lo* architecture. One rectangular parasitic patch with length L_u and width W_u is mounted on the top of a low index dielectric substrate with thickness h_u , dielectric constant ϵ_{ru} , and loss tangent $\tan\delta_u$. The middle and bottom layers work together as the lower metamaterial substrate. For the middle layer, a driven patch is adhering to another dielectric with h_1 , ϵ_{r1} , and $\tan\delta_1$. It has a different patch size of $L \times W$. The

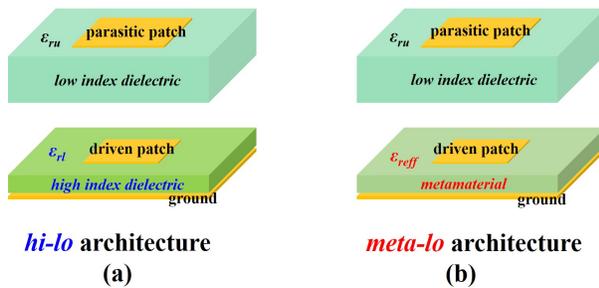


Fig. 1. Comparison of (a) *hi-lo* architecture, and (b) *meta-lo* architecture to build a compact stacked patch antenna.

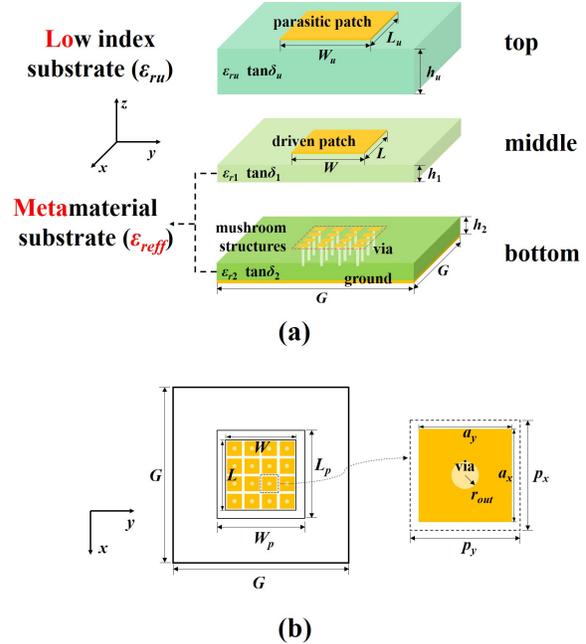


Fig. 2. The configuration of the conceptual SMPA in the (a) overview, and (b) top view.

bottom layer is however more complex. As shown in Fig. 2 (b), it is embedded with numerous composite mushroom structures. These composite structures are periodically distributed beneath the drive patch. The period is p_x along the x axis, and p_y along the y axis. The total number of these structures is $m \times n$ ($L = m \times p_x$ and $W = n \times p_y$). Each mushroom element consists of a rectangular metallic “cap” mounted on the bottom dielectric, and a cylindrical conducting via perforated in the bottom substrate. The cap is connected to the ground plane by via. The mushroom cap is supposed with size of $a_x \times a_y$. And the perforated via is with an outer radius of r_{out} . The ground plane is a square with side length of G . The bottom dielectric is with h_2 , ϵ_{r2} , and $\tan\delta_2$. All of the metal layers are very thin with a small thickness of t . And all of the substrate layers are made of low permittivity dielectrics.

The SMPA in Fig. 2 can be viewed from two perspectives. The first perspective is that the SMPA is physically made of three layers of low permittivity dielectrics with ϵ_{ru} , ϵ_{r1} , and ϵ_{r2} , respectively. And the second view is from the equivalent metamaterial perspective. The SMPA is built up from one low permittivity dielectric (equivalent to the top layer) with ϵ_{ru} , and another metamaterial substrate (equivalent to the middle and bottom layers) with ϵ_{reff} , following the *meta-lo* architecture.

We now discuss the ϵ_{reff} of the metamaterial substrate. As seen in Fig. 2, the metamaterial substrate is loaded with periodic mushroom structures in the middle and bottom layers. These composite structures can be

well treated as homogenous metamaterials on condition that p_x and p_y are much smaller than wavelength (generally less than 0.1λ). A simple formula can be used to describe the ϵ_{reff} as [20]:

$$\epsilon_{reff} \approx \epsilon_{r1} \frac{h_1 + h_2}{h_1}, \quad (1)$$

when $a_x \approx p_x$, and $a_y \approx p_y$.

Eqn (1) shows how to realize high effective permittivity metamaterials from natural low index dielectrics. The underlying mechanism is attributed to the enhanced capacitive effects in the metamaterial substrate than the original host dielectric [20]. The enhancing ratio is nearly $(h_1+h_2)/h_1$. This functionality of mushroom structures is quite different from the previous high impedance surface (HIS) in [22], despite of their similar configurations. Note that the HIS requires the p_x and p_y to be close to half wavelength (usually 0.3 to 0.5λ). The SMPA can be fed using various methods [4], e.g., a coaxial probe, or coupling from an aperture on the ground plane etc. To validate the concept, a practical probe-fed SMPA is designed in the following section. Its compact and broadband characteristics are demonstrated in both full wave simulations and experiments.

III. DESIGN AND RESULTS

One SMPA based on the *meta-lo* architecture is considered operating in the Sub-6GHz band for the broadband 5G communications. The parameters are initialized by designing a narrowband metamaterial antenna [20], which is relatively simple. The middle and bottom layers are made of SCGA-500 GF300 by Shengyi Technology Co., Ltd. (SYTECH) with $\epsilon_{r1} = \epsilon_{r2} = 3$, and $\tan\delta_1 = \tan\delta_2 = 0.0023$. Their thickness values are $h_1 = h_2 = 1.52$ mm. The driven patch is a square with $L = W = 16$ mm. The ground length is $G = 50$ mm. The mushroom structures are with $p_x = p_y = 4$ mm, $a_x = a_y = 3.4$ mm, and $r_{out} = 0.4$ mm. Using the L and ϵ_{reff} in eqn (1), this narrowband antenna is predicted to resonate at nearly 3.83 GHz.

Next, we attempt to broaden the BW by adding a parasitic patch fabricated on an additional top substrate. The top substrate is chosen to be F4BM220 provided by Taizhou Wangling insulating materials factory, with $\epsilon_{ru} = 2.2$ and $\tan\delta_u = 0.001$. Its thickness is $h_u = 5$ mm, inspired by the recommended ratio of h_u over (h_1+h_2) in [23]. After that, we will design the parasitic patch. The parasitic patch is still a square but with length slightly larger than the driven patch. Four typical parasitic patch sizes are chosen as $L_u = W_u = 18, 19, 20$ and 21 mm. In addition, all of the metal layers are made of copper with thickness $t = 0.035$ mm. The antenna is fed by a 50Ω coaxial probe between the drive patch and ground plane [4, 23]. The SMPAs are numerically studied in the HFSS solver based on the finite-element method. The full-wave sim-

Table 1: Simulated BW for some stacked antennas

$L_u = W_u$ (mm)	x_1 (mm)	-10 dB BW %	Protuberance point dB
19	7	3.52–4.46 GHz 23.6%	-10.9 dB
20	6	3.36–4.4 GHz 26.8%	-12.4 dB
20	7	3.394–4.4 GHz 25.8%	-13.9 dB
21	6	3.28–4.28 GHz 26.5%	-11.9 dB
21	7	3.32–4.28 GHz 25.3%	-12.9 dB

ulated reflection coefficients (S_{11} s) for the cases of $L_u = W_u = 18, 19, 20$, and 21 mm are shown in Figs. 3 (a)–(d), respectively, which are optimized by tuning the feeding position x_1 . The x_1 is measured from the center of driven patch to the probe position, in the range from 0 to $L/2$.

It is observed in Fig. 3 that the all of these SMPAs have dual resonant frequencies, originated from the couplings between the parasitic and driven patches [1–8]. It makes it possible to broaden the BW. However the “protuberance point” (the locally highest point between the dual resonant frequencies in the S_{11} curve) levels for some antennas are higher than -10 dB. Therefore, they cannot be regarded as broadband antennas, but work as “dual-band” antennas. By removing these dual-band antennas away, we finally have five potential broadband SMPAs in Table 1. Their -10 dB BWs are all very close at the order of 25%. In theory, all of these five antennas

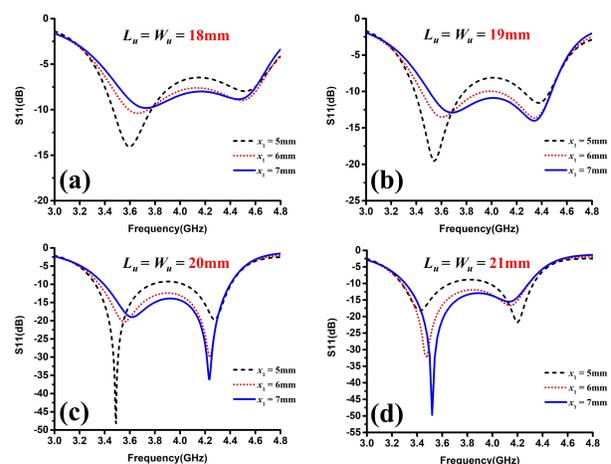


Fig. 3. The full-wave calculated S_{11} s for the SMPAs with $L_u = W_u =$ (a) 18 mm, (b) 19 mm, (c) 20 mm, and (d) 21 mm, optimized by tuning the feeding position x_1 .

can work. However, the “protuberance point” levels are different. Considering the practical S11 may get worse than prediction, we conservatively choose the case of $L_u = W_u = 20$ mm and $x_1 = 7$ mm, since it is with the lowest “protuberance point” of nearly -13.9 dB.

A particular SMPA is further fabricated following the optimal parameters. The SMPA in the experimental demonstration is assembled from three laminate layers. They are independently fabricated and then manually assembled together. The three different layers are shown in Fig. 4 (a). We remark that in addition to the fabrication precision (e.g., the patch size, radius of vias, dielectric constant of materials, etc.), the accuracy in the assembling work will influence the antenna performances as well. Hence one needs to be very careful when assembling the antenna. To install the coaxial probe, the middle and bottom layers should be tightly compressed with nylon screws, in order to remove the potential air layer between the dielectrics. To allow the inner pin of the feeding probe to pass through the substrates without contacting mushroom caps, some mushroom structures are deliberately designed defected around the feeding point, as shown in Fig. 4 (a). After fixing the probe, the nylon screws which were used before to attach the middle and bottom layers, are temporarily detached. The top thick substrate layer is now added and made together with the lower two layers, still with the help of nylon screws. Fig. 4 (b) shows the finally assembled SMPA.

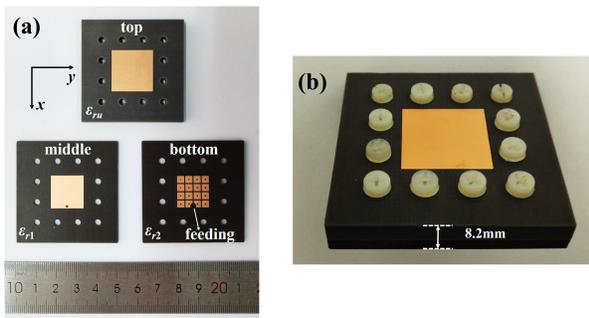


Fig. 4. Photograph of (a) the three different layers, and (b) the assembled SMPA.

The SMPA in the demonstration is made by manually compacting laminate layers. It requires the laminates to be with flat surfaces, even after the PCB fabrication. Therefore, it is not recommended to use those “soft” materials (such as pure Teflon etc.) as the candidate laminates since they are very likely to be wrapped, which is harmful to the antenna assembling. A better fabrication method is to use a multilayer PCB process, without the need of trivially packaging the laminate layers by hand.

The simulated and measured S11s of the SMPA are shown in Fig. 5. Results are in good agreement. It seems

to resonate at dual frequencies of about 3.6 GHz and 4.25 GHz. The simulated BW is 1.006 GHz (25.8%) from 3.394 to 4.4 GHz, while the measured result is slightly wider as 1.056 GHz (27.1%), from 3.371 to 4.427 GHz. The “protuberance point” is -13.9 dB in simulation and deteriorates to -13.5 dB in measurement, both at near 3.9 GHz. Note that the measured “protuberance point” is 3.5 dB lower than the -10 dB line, it is a relatively conservative level. In order to further broaden the BW, the “protuberance point” can be designed higher near the -10 dB line, as shown in some cases in Table 1.

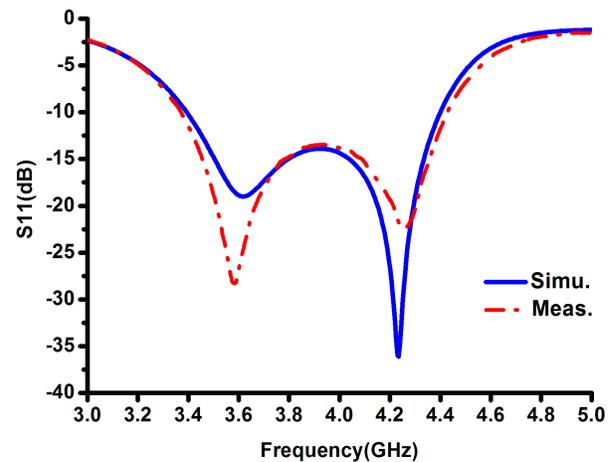


Fig. 5. The simulated and measured S11s of the SMPA.

In Fig. 5, the measured f_c in the BW is 3.899 GHz that corresponds to $\lambda = 76.9$ mm. By normalizing the antenna size to λ , the driven patch is featured with an electrically small area of $0.21\lambda \times 0.21\lambda$. The parasitic patch is larger that is $0.26\lambda \times 0.26\lambda$. The total thickness of the SMPA is 8.2 mm or electrically 0.107λ , including all dielectric and metal layers. After these estimations, we conclude that the SMPA in the demonstration occupies a volume of $0.26\lambda \times 0.26\lambda \times 0.107\lambda$, which is much more compact than the air-filled stacked patch antennas [7, 8] with a patch length of nearly 0.5λ or longer.

The broadband characteristics of the conceptual SMPA are also studied by measuring the antenna gain using a gain-comparison method [24]. Results are given in Fig. 6. The antenna gain curve, either from simulation or measurement, is seen very flat around 7 dBi in the operating BW. However, it descends dramatically when frequencies are out of band, resulted from the reflection loss. The simulated peak gain predicted from HFSS is about 7.6 dBi occurring at near 4.25 GHz and above 6.4 dBi in the entire BW. The measured gain curve seems less smooth. The peak antenna gain is about 8.1 dBi, still at near 4.25 GHz. In the BW, the measured antenna

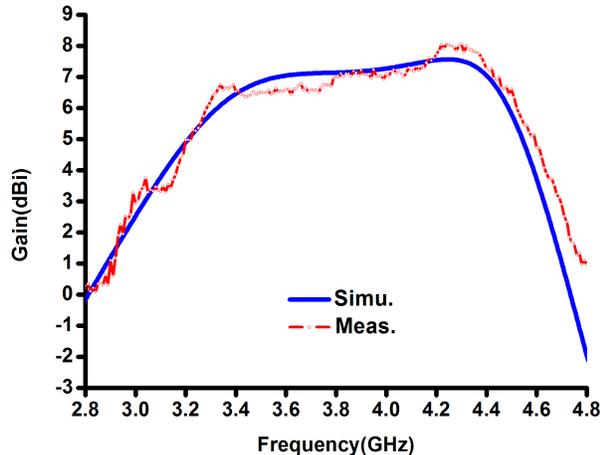


Fig. 6. The antenna gain.

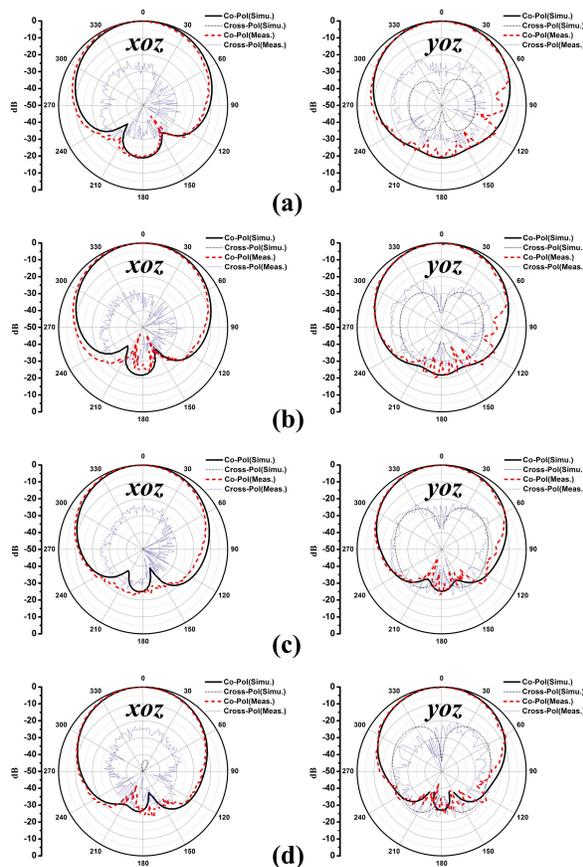


Fig. 7. The radiation patterns at (a) 3.44 GHz, (b) 3.72 GHz, (c) 4.04 GHz, and (d) 4.32 GHz.

gain is all over 6.35 dBi. To better evaluate the broadband characteristics, a more significant statistical phrase “average gain” is used which is defined by algebraically

Table 2: Comparison of different stacked antennas

Design	Small	Broad-band	High per-mittivity dielectrics	Ref.
<i>lo-lo</i>	No	Yes	Not need	[6–8]
<i>hi-lo</i>	Yes	Yes	Need	[1–3]
<i>meta-lo</i>	Yes	Yes	Not need	This

averaging all gain values in the BW. The simulated average gain for the SMPA is about 7.2 dBi, in agreement with the measured 7.1 dBi.

The radiation patterns of the SMPA are numerically calculated and measured at four typical frequencies (3.44, 3.72, 4.04, and 4.32 GHz) so as to cover the BW as possible. Results are given in Figs. 7 (a)–(d) respectively. For each frequency, the left patterns are obtained on the *xoy* plane (E plane) and the right ones are on the *yozy* plane (H plane). The simulated co-polarized radiation patterns are quite similar with the measured ones. The back lobes are much lower than the main lobes at the backside. An interesting trend is seen that the back lobe is becoming more suppressed when the frequency is higher. It is -19 dB at 3.44 GHz, and reduced to -27 dB at 4.32 GHz in the simulation.

The cross-polarizations are also revealed in Fig. 7. We first discuss the cases on the E plane. From the left column in Fig. 7, it is observed that the calculated cross-polarized fields on the E plane are at the order of or lower than -50 dB. They are too low to be seen. However, the measured cross-polarizations are about -23 dB. The difference might be due to the imperfection of the antenna sample. Another reason might be attributed to the measuring environment that the -50 dB level in simulation is actually too low to be detected in measurement. Now we look at the H plane patterns along the right column of Fig. 7. The simulated cross-polarizations on the H plane are seen much higher than the E plane. They are about -30 dB at 3.44 GHz, and increase to -18.3 dB at 4.32 GHz. The measured cross-polarizations are all at the order of -20 dB in the broadband. They are below -19.7 dB at 3.44 GHz and -17.7 dB at 4.32 GHz. The measured cross-polarization levels on the H plane are in consistency with the simulated levels, especially for high frequency cases. In brief, the cross-polarizations for the SMPA can be all controlled less than -17 dB in the broad band.

The performances for three different stacked patch antenna architectures are summarized in Table 2. In the first design, both of the upper and lower dielectrics are made of low permittivity dielectrics [6–8] that this design is named as the *lo-lo* architecture as proposed in [1]. The upper dielectric is usually the air or foam that $\epsilon_{ru} \approx 1$. The *lo-lo* architecture exhibits broadband characteristics

but associated with large antenna patches. For the second *hi-lo* architecture, the antenna sizes can be made smaller. The limitation is that high permittivity dielectrics are necessary. In the third *meta-lo* architecture, the stacked antennas can be designed compact and simultaneously, broadband, which take advantage of all low permittivity dielectrics. The high permittivity dielectrics are not necessary in the new design.

IV. CONCLUSION

A new *meta-lo* architecture is proposed to design a compact and broad SMPA. The conceptual SMPA is all made of low dielectric constant materials. One particular probe-fed SMPA is experimentally demonstrated. It is shown with a broad impedance BW of 27%. The lateral patch dimension is $0.26\lambda \times 0.26\lambda$. And the vertical profile is 0.107λ . The measured average antenna gain is about 7.1 dBi in the broad BW. These characteristics make the SMPA a promising component in applications of portable broadband communications.

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